



for

LED

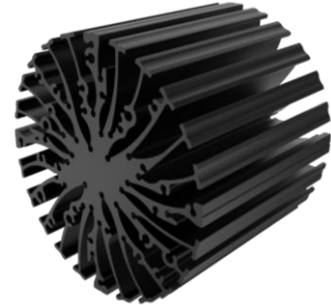


EtraLED

EtraLED-LG-9680 LG Innotek Modular Passive Star Heat Sink Φ 96mm

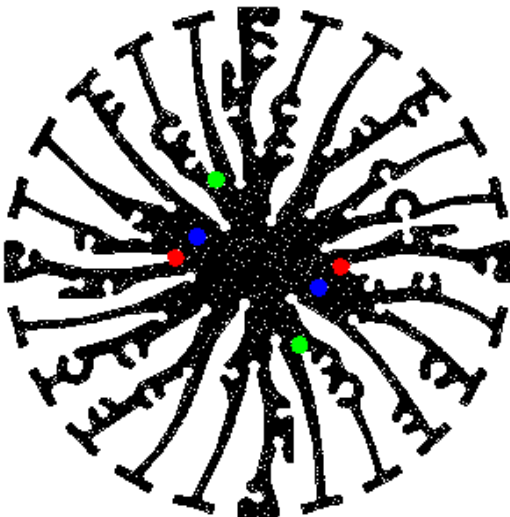
Features VS Benefits

- * The EtraLED-LG-9680 LG Innotek Modular Passive Star LED Heat Sinks are specifically designed for luminaires using the LG Innotek LED engines.
- * Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 2500 to 6,200 lumen.
- * Thermal resistance range R_{th} 1.20°C/W.
- * Modular design with mounting holes foreseen for direct mounting of LG Innotek COB series.
- * Diameter 96.0mm - standard height 80.0mm Other heights on request.
- * Forged from highly conductive aluminum.



Zhaga LED engine and radiator assembly is a unified future international standardization

- * Below you find an overview of LG Innotek COB's and LED modules which standard fit on the srar LED heat sinks.
- * In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of srar LED heat sinks.



LG Innotek LED Modules directly Mounting Options

LG Innotek 7W&10W COB series.

- LEMWM19480xxxxxx;
- LEMWM19490xxxxxx;
- LEMWM19680xxxxxx;
- LEMWM19690xxxxxx;

- With the Zhaga Book 3 holders for the green indicator marks.
- TE Connectivity Holder: 2213382-1;
- Without the holders for the blue indicator marks.
- Direct mounting with machine screws M3x6.5mm.

LG Innotek 16W&21W COB series.

- LEMWM24780xxxxxx;
- LEMWM24790xxxxxx;
- LEMWM24980xxxxxx;
- LEMWM24990xxxxxx;

- With the Zhaga Book 3 holders for the green indicator marks.
- TE Connectivity Holder: 2213130-1;
- BJB Holder:47.319.2011.50;
- Without the holders for the red indicator marks.
- Direct mounting with machine screws M3x6.5mm.

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Mounting Options and Drawings & Dimensions

Example: EtraLED-LG-9680-B-1,2

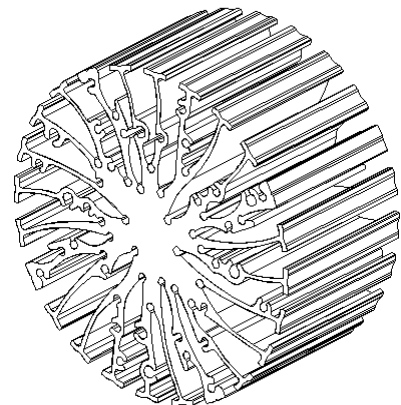
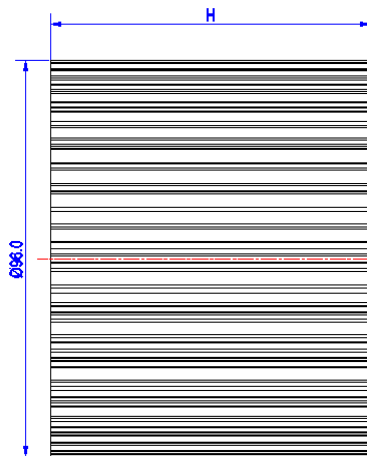
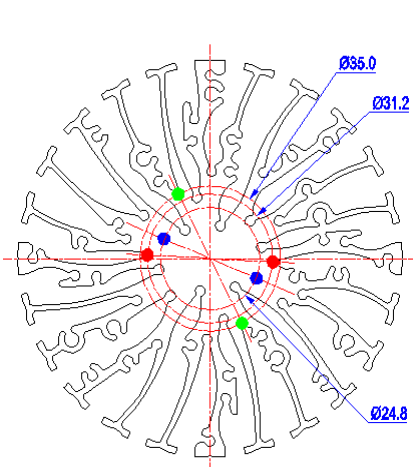
Example: EtraLED-LG-96 **1** - **2** - **3**

- 1** Height (mm)
- 2** Anodising Color
B-Black
C-Clear
Z-Custom
- 3** Mounting Options - see graphics for details Combinations available
Ex.order code - 12
means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
1	7W&10W COB	/	M3	6.5mm	24.8mm/ 2-@180°
2		/	M3	6.5mm	31.2mm/ 2-@180°
3	16W&21W COB	BJB Holder 47.319.2011.50	M3	6.5mm	35.0mm/ 2-@180° (Zhaga Book 3)
		TE Holder 2213130-1			
	7W&10W COB	TE Holder 2213382-1			



EtraLED

EtraLED-LG-9680 LG Innotek Modular Passive Star Heat Sink Φ96mm

The product data table

	Model No.	EtraLED-LG-9680
	Heatsink Size	Φ96xH80mm
	Heatsink Material	AL6063-T5
	Finish	Black Anodized
	Weight (g)	575.0
	Dissipated power (T_{hs-amb},50°C)	41.5 (W)
	Cooling surface area (mm²)	180427
	Thermal Resistance (R_{hs-amb})	1.2 (°C/W)

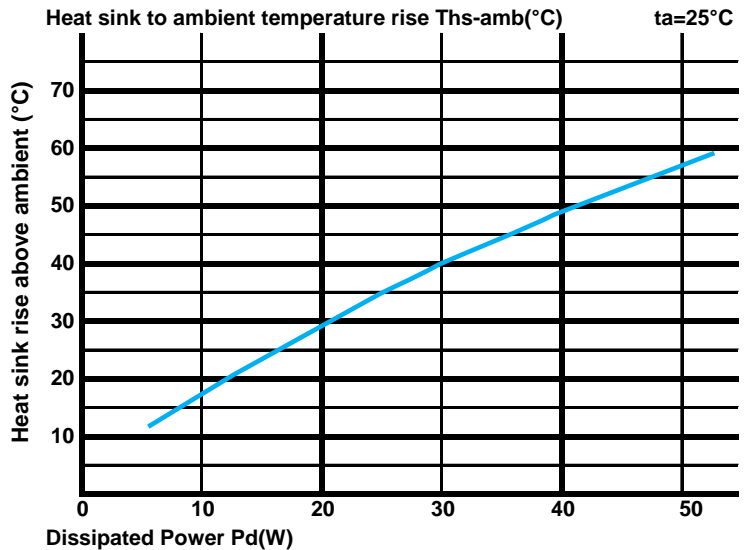
The thermal data table

* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

*To calculate the dissipated power please use the following formula: Pd = Pe x (1-ηL).

Pd - Dissipated power ; Pe - Electrical power ; ηL = Light efficiency of the LED module;

Dissipated Power Pd(W)	Pd = Pe x (1-ηL)	Heat sink to ambient thermal resistance R _{hs-amb} (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
		EtraLED-LG-9680	
10.0		1.70	17.0
20.0		1.45	29.0
30.0		1.33	40.0
40.0		1.20	48.0
50.0		1.12	56.0



*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease, A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.



*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow.

Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (T_{hs} - T_a) / P_d$

θ - Thermal Resistance [°C/W]; T_{hs} - Heatsink temperature ; T_a - Ambient temperature ;

*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is $R_{\text{junction-case}}$, the thermal resistance of the TIM outside the package is $R_{\text{interface (TIM)}}$ [°C/W], the thermal resistance with the heat sink is $R_{\text{heatsink-ambient}}$ [°C/W], and the ambient temperature is T_{ambient} [°C].

*Thermal resistances outside the package $R_{\text{interface (TIM)}}$ and $R_{\text{heatsink-ambient}}$ can be integrated into the thermal resistance $R_{\text{case-ambient}}$ at this point. Thus, the following formula is also used:

$$T_{\text{junction}} = (R_{\text{junction-case}} + R_{\text{case-ambient}}) \cdot P_d + T_{\text{ambient}}$$